2SD1749, 2SD1749A

Silicon NPN triple diffusion planar type darlington

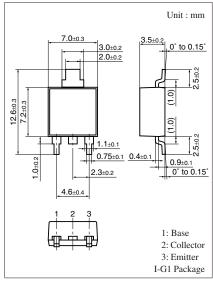
For low-frequency power amplification Complementary to 2SB1179 and 2SB1179A

■ Features

- \bullet High forward current transfer ratio h_{FE}
- High-speed switching
- I type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment

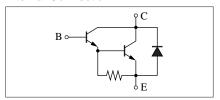
■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit		
Collector-base voltage	2SD1749	V_{CBO}	60	V	
(Emitter open)	2SD1749A		80		
Collector-emitter voltage	2SD1749	V _{CEO}	60	V	
(Base open)	2SD1749A		80		
Emitter-base voltage (Coll	V_{EBO}	5	V		
Collector current	I_C	4	A		
Peak collector current	I_{CP}	8	A		
Collector power dissipation	P _C	15	W		
	$T_a = 25$ °C		1.3		
Junction temperature	T _j	150	°C		
Storage temperature	T_{stg}	-55 to +150	°C		



Note) Self-supported type package is also prepared.

Internal Connection

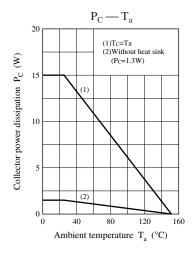


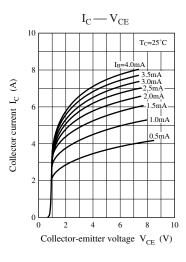
■ Electrical Characteristics $T_C = 25$ °C ± 3 °C

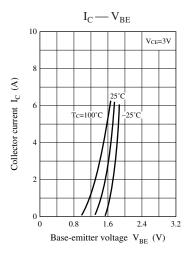
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage 25	2SD1749	V_{CEO}	$I_C = 30 \text{ mA}, I_B = 0$	60			V
(Base open)	2SD1749A			80			
Base-emitter voltage		V_{BE}	$V_{CE} = 3 \text{ V}, I_{C} = 3 \text{ A}$			2.5	V
Collector-base cutoff current (Emitter open)	2SB1749	I_{CBO}	$V_{CB} = 60 \text{ V}, I_{E} = 0$			200	μΑ
	2SB1749A		$V_{CB} = 80 \text{ V}, I_{E} = 0$			200	
Concetor emitter editori	2SB1749	I_{CEO}	$V_{CE} = 30 \text{ V}, I_{B} = 0$			500	μΑ
	2SB1749A		$V_{CE} = 40 \text{ V}, I_{B} = 0$			500	
Emitter-base cutoff current (Collector open)		I_{EBO}	$V_{EB} = 5 \text{ V}, I_{C} = 0$			2	mA
Forward current transfer ratio		h _{FE1}	$V_{CE} = 3 \text{ V}, I_{C} = 0.5 \text{ A}$	1000			_
		h _{FE2} *	$V_{CE} = 3 \text{ V}, I_{C} = 3 \text{ A}$	2000		10 000	
Collector-emitter saturation voltage		V _{CE(sat)}	$I_C = 3 \text{ A}, I_B = 12 \text{ mA}$			2.0	V
			$I_C = 5 \text{ A}, I_B = 20 \text{ mA}$			4.0	
Forward current transfer rat	io	f_T	$V_{CE} = 10 \text{ V}, I_{C} = 0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Turn-on time		t _{on}	I _C = 3 A, I _{B1} = 12 mA, I _{B2} = - 12 mA V _{CC} = 50 V		0.5		μs
Storage time		t _{stg}			4.0		μs
Fall time		$t_{\rm f}$			1.0		μs

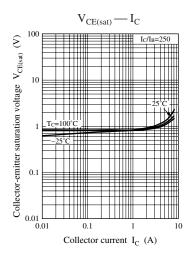
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

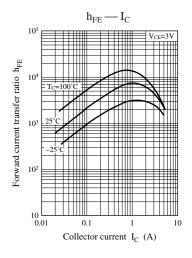
2. *: Rank classification	Rank	Q	Р
	h _{FF2}	2000 to 5000	4000 to 10000

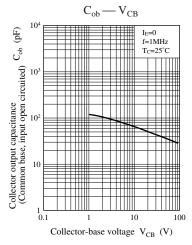


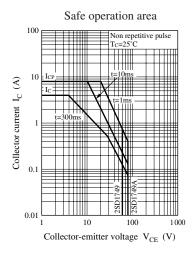


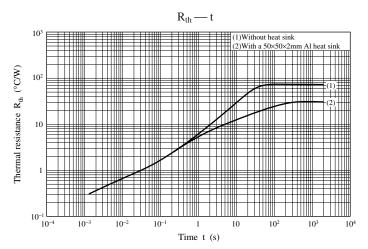












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